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[Signature]

Atty Docket No.: TKHR4580

Serial No.: 09/479,483

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of :

Application No. : 09/479,483

Filed : January 10, 2000

For : Fabrication Method for a Multi-Layered Thin Film Protective Layer ✓

Applicant : Chen et al.

Examiner : Fourson III, George R

Art Unit : 2823

No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-0710 (Order No. TKHR4580).

**AMENDMENT AND RESPONSE TO OFFICE ACTION****BOX Non-Fee Amendment**

Commissioner of Patents and Trademarks  
Washington, DC 20231

**FAX COPY RECEIVED**

SEP 30 2002

TECHNOLOGY CENTER 2800

Sir:

In response to the Office Action dated July 5, 2002, please enter the following amendments and consider the following remarks.

**In The Specification:**

Please substitute the following clean text paragraph for the pending paragraph beginning at line 16 on page 6.

31  
--Thereafter, a second protective layer etching process is conducted to define the positions of protective layer in the peripheral circuit area 104 and the pad spacers. Referring to Figure 1E, the positions for the protective layer 122 of the peripheral circuit area 104 and the pad spacers 118b